TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

TC74HCT138AP,TC74HCT138AF

3-to-8 Line Decoder

The TC74HCT138A is a high speed CMOS 3-to-8 LINE DECODER fabricated with silicon gate C²MOS technology.

It achieves the high speed operation similar to equivalent LSTTL while maintaining the CMOS low power dissipation.

This device may be used as a level converter for interfacing TTL or NMOS to High Speed CMOS. The inputs are compatible with TTL, NMOS and CMOS output voltage levels.

When the device is enabled, 3 Binary Select inputs (A, B and C) determine which one of the outputs ($\overline{Y}0 - \overline{Y}7$) will go low.

When enable input G1 is held low or either $\overline{G}2A$ or $\overline{G}2B$ is held high, decoding function is inhibited and all outputs go high.

 $G1,\overline{G}2A$, and $\overline{G}2B$ inputs are provided to ease cascade connection and for use as an address decoder for memory systems.

All inputs are equipped with protection circuits against static discharge or transient excess voltage.

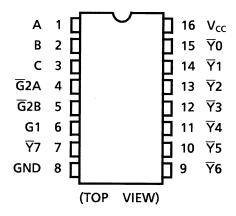
Features

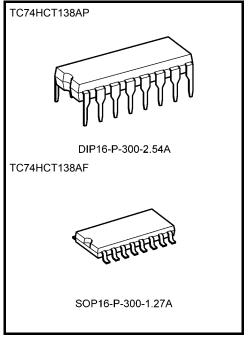
- High speed: $t_{pd} = 17 \text{ ns (typ.)}$ at $V_{CC} = 5 \text{ V}$
- Low power dissipation: $I_{CC} = 4 \mu A \text{ (max)}$ at $T_{a} = 25 \text{°C}$
- Compatible with TTL outputs: V_{IH} = 2 V (min)

$$V_{\rm IL} = 0.8 \text{ V (max)}$$

- Wide interfacing ability: LSTTL, NMOS, CMOS
- Output drive capability: 10 LSTTL loads
- Symmetrical output impedance: | I_{OH} | = I_{OL} = 4 mA (min)
- Balanced propagation delays: $t_{pLH} \approx t_{pHL}$
- Pin and function compatible with 74LS138

Pin Assignment

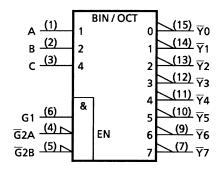


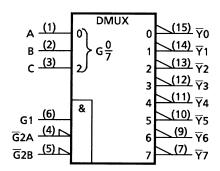


Weight

DIP16-P-300-2.54A : 1.00 g (typ.) SOP16-P-300-1.27A : 0.18 g (typ.)

IEC Logic Symbol



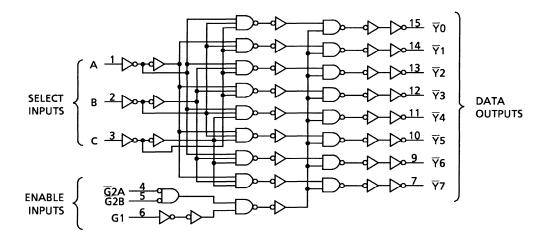


Truth Table

	Inputs					Outputs									
Enable		Select		7 0	- Y1	<u></u>	7 3	<u>7</u> 4	<u>-</u> Y5	- Y6	7 7	Selected Output			
G1	G ₂ A	G ₂ B	С	В	Α	10	T I	12	13	1 4	13	10	1 7	·	
L	Х	Х	Х	Х	Х	Н	Н	Н	Н	Н	Н	Н	Н	None	
Х	Н	Х	X	X	Х	Н	Η	Н	Н	Н	Н	Н	Н	None	
Х	Х	Н	Х	Х	Х	Н	Н	Н	Н	Н	Н	Н	Н	None	
Н	L	L	L	L	L	L	Н	Н	Н	Н	Н	Н	Н	₹0	
Н	L	L	L	L	Н	Н	L	Н	Н	Н	Н	Н	Н	- 71	
Н	L	L	L	Н	L	Н	Н	L	Н	Н	Н	Н	Н	₹2	
Н	L	L	L	Н	Н	Н	Н	Н	L	Н	Н	Н	Н	Y 3	
Н	L	L	Н	L	L	Н	Н	Н	Н	L	Н	Н	Н	Y 4	
Н	L	L	Н	L	Н	Н	Н	Н	Н	Н	L	Н	Н	₹5	
Н	L	L	Н	Н	L	Н	Н	Н	Н	Н	Н	L	Н	Y 6	
Н	L	L	Н	Н	Н	Н	Н	Н	Н	Н	Н	Н	L	Y 7	

X: Don't care

Logic Diagram



Absolute Maximum Ratings (Note 1)

Characteristics	Symbol	Rating	Unit
Supply voltage range	V _{CC}	-0.5~7.0	V
DC input voltage	V _{IN}	-0.5~V _{CC} + 0.5	٧
DC output voltage	Vout	-0.5~V _{CC} + 0.5	V
Input diode current	Ι _{ΙΚ}	±20	mA
Output diode current	lok	±20	mA
DC output current	lout	±25	mA
DC V _{CC} /ground current	Icc	±50	mA
Power dissipation	P _D	500 (DIP) (Note 2)/180 (SOP)	mW
Storage temperature	T _{stg}	-65~150	°C

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 2: 500 mW in the range of Ta = -40 to $65^{\circ}C$. From Ta = 65 to $85^{\circ}C$ a derating factor of -10 mW/°C shall be applied until 300 mW.

Operating Ranges (Note)

Characteristics	Symbol	Rating	Unit
Supply voltage	V _{CC}	4.5~5.5	V
Input voltage	V _{IN}	0~V _{CC}	V
Output voltage	V _{OUT}	0~V _{CC}	V
Operating temperature	T _{opr}	-40~85	°C
Input rise and fall time	t _r , t _f	0~500	ns

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either VCC or GND.

Electrical Characteristics

DC Characteristics

Characteristics	Symbol	Test Condition			-	Га = 25°(Ta = -40~85°C		Unit
Characteristics	Symbol			V _{CC} (V)	Min	Тур.	Max	Min	Max	Offic
High-level input voltage	V _{IH}	_		4.5~5.5	2.0	_	_	2.0		V
Low-level input voltage	V _{IL}	_		4.5~5.5		_	0.8	_	0.8	٧
High-level output	V _{OH}	V _{IN} = V _{IH} or V _{IL}	$I_{OH} = -20~\mu A$	4.5	4.4	4.5	_	4.4	_	V
voltage			$I_{OH} = -4 \text{ mA}$	4.5	4.18	4.31		4.13	_	
Low-level output	V _{OL}	V _{IN} = V _{IH} or V _{IL}	$I_{OL}=20~\mu A$	4.5	_	0.0	0.1	_	0.1	\
voltage			$I_{OL} = 4 \text{ mA}$	4.5		0.17	0.26	_	0.33	v
Input leakage current	I _{IN}	V _{IN} = V _{CC} or GND		5.5		_	±0.1	_	±1.0	μΑ
	Icc	$V_{IN} = V_{CC}$ or	GND	5.5	_	_	4.0	_	40.0	μΑ
Quiescent supply current	IC	Per input: V _{IN} = 0.5 V or 2.4 V Other input: V _{CC} or GND		5.5	_	_	2.0	_	2.9	mA



AC Characteristics ($C_L = 15 \text{ pF}$, $V_{CC} = 5 \text{ V}$, $Ta = 25^{\circ}\text{C}$, input: $t_r = t_f = 6 \text{ ns}$)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Output transition time	t _{TLH}	_		4	8	ns
	t _{THL}					
Propagation delay time	t _{pLH}			17	28	ns
$(A, B, C-\overline{Y})$	t_{pHL}			17	20	113
Propagation delay time	t_{pLH}			15	25	ns
$(G1-\overline{Y})$	t_{pHL}			2	25	113
Propagation delay time	t _{pLH}			17	28	ns
(G 2 - Y)	t_{pHL}			17	20	115

AC Characteristics ($C_L = 50 \text{ pF}$, input: $t_r = t_f = 6 \text{ ns}$)

Characteristics	Symbol	Test Condition		-	Га = 25°C		Ta = -40~85°C		Unit	
Characteristics	Syllibol		V _{CC} (V)	Min	Тур.	Max	Min	Max	Offic	
Output transition time	t _{TLH}		4.5	_	8	15	_	19	ns	
Output transition time	t _{THL}	_	5.5	_	7	14	_	18		
Propagation delay time	t _{pLH}	_	4.5	_	21	33	_	44	ns	
(A, B, C- \overline{Y})	t_{pHL}	_	5.5	_	18	30	_	40	113	
Propagation delay time	t _{pLH}	_	4.5	_	19	30	_	38	ns	
(G1- \overline{Y})	t_{pHL}		5.5	_	17	27	_	34	110	
Propagation delay time	t _{pLH}		4.5	_	22	33	_	41	ns	
(G 2 - Y)	t _{pHL}	_	5.5	_	20	30	_	37	115	
Input capacitance	C _{IN}	_		_	5	10	_	10	pF	
Power dissipation capacitance	C _{PD} (Note)	_		_	55	_	_	_	pF	

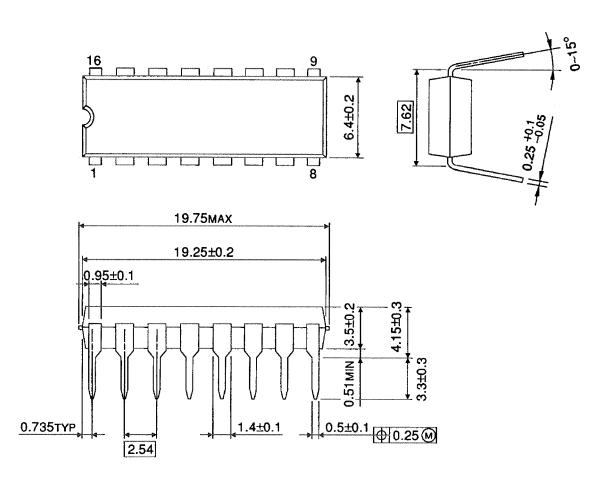
Note: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation:

$$I_{CC}$$
 (opr) = $C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}$

Package Dimensions

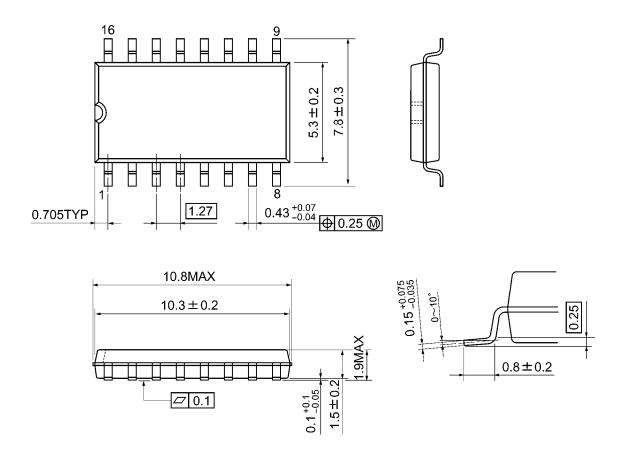
DIP16-P-300-2.54A Unit: mm



Weight: 1.00 g (typ.)

Package Dimensions

SOP16-P-300-1.27A Unit: mm



Weight: 0.18 g (typ.)

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